

FIG. 1

FIG. 2A

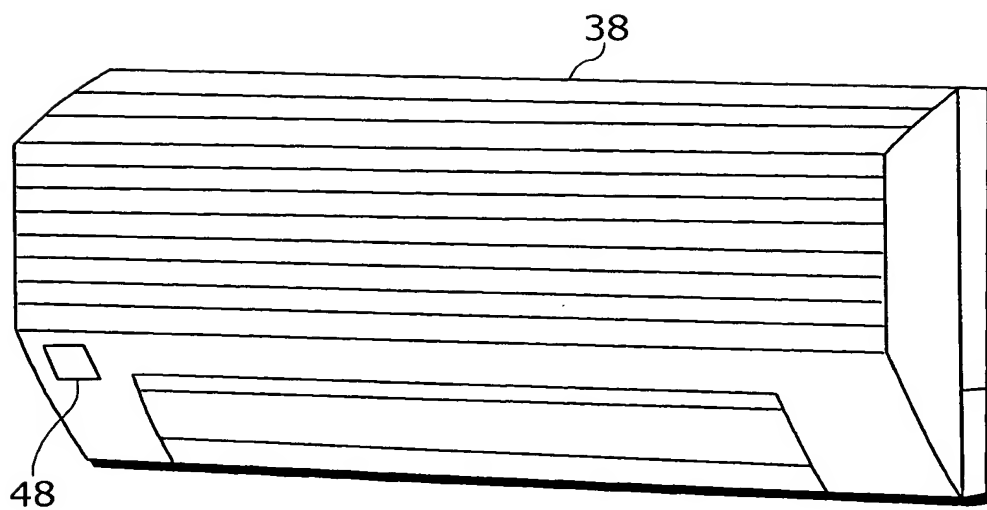


FIG. 2B

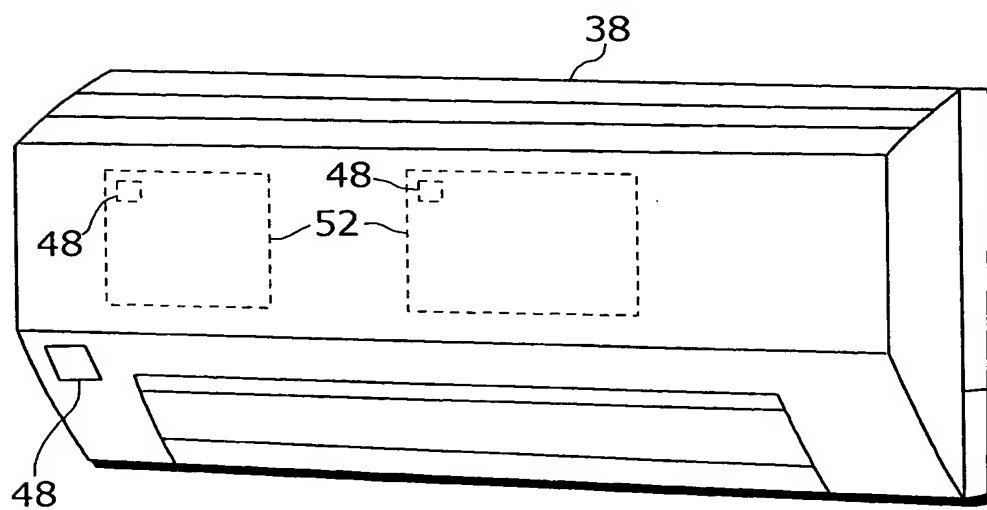


FIG. 3

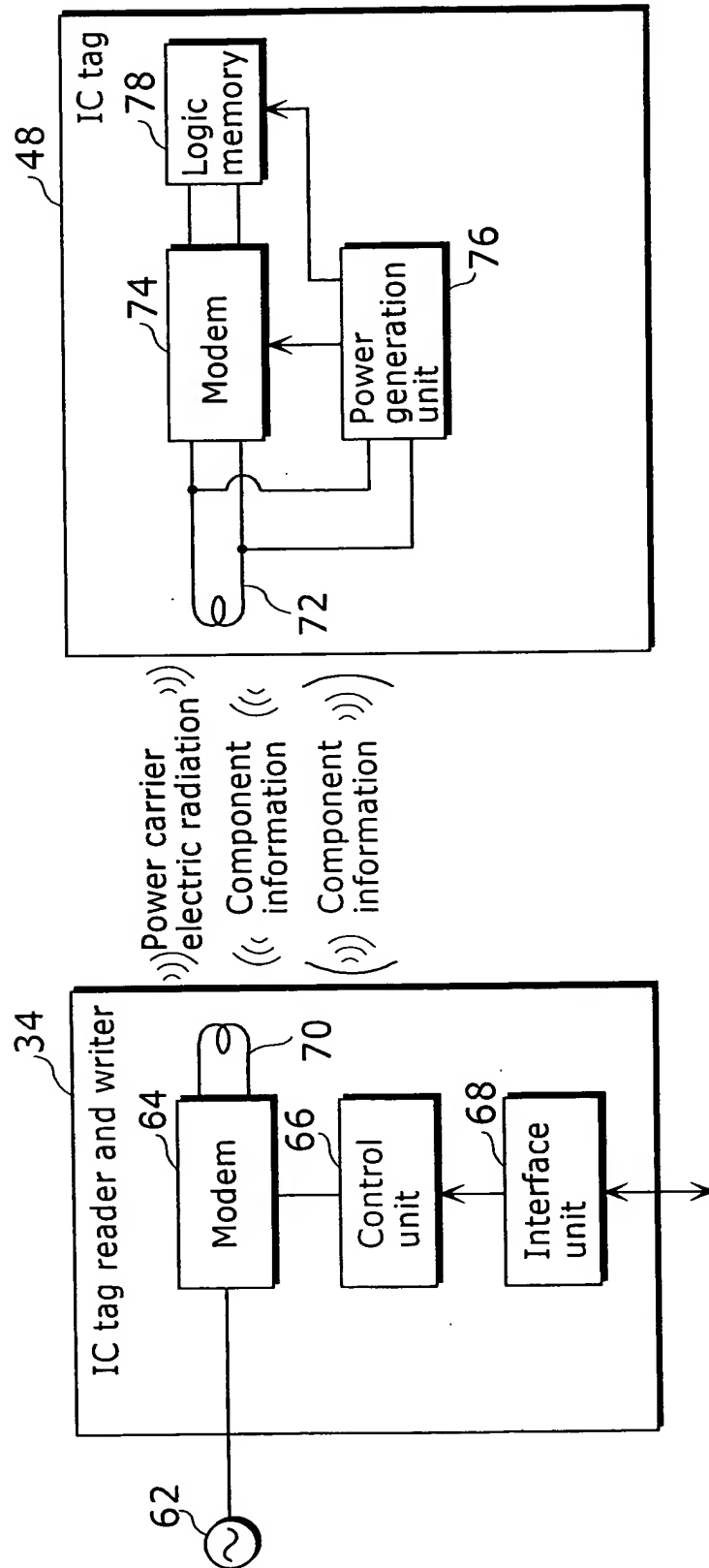


FIG. 4

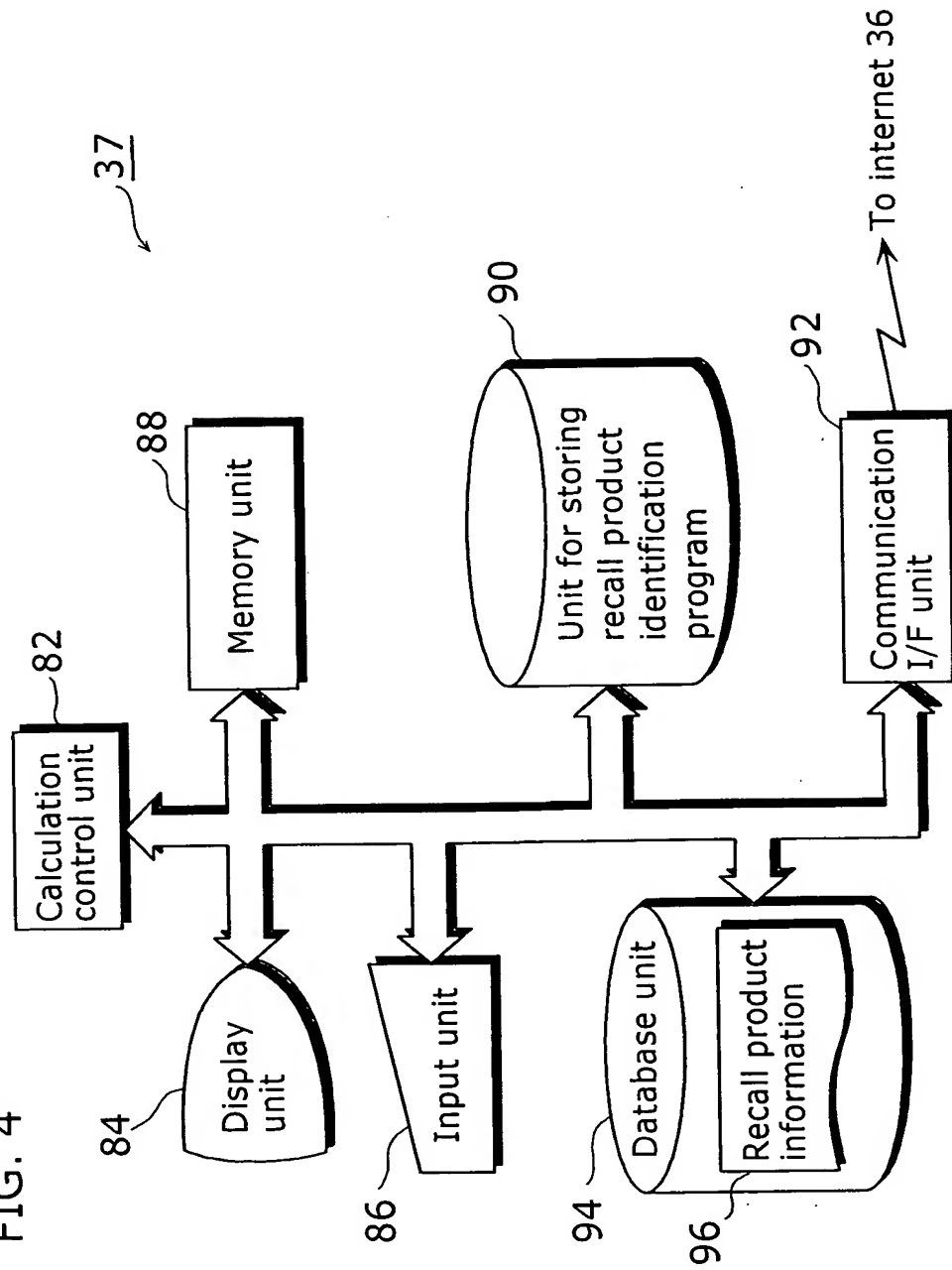


FIG. 5

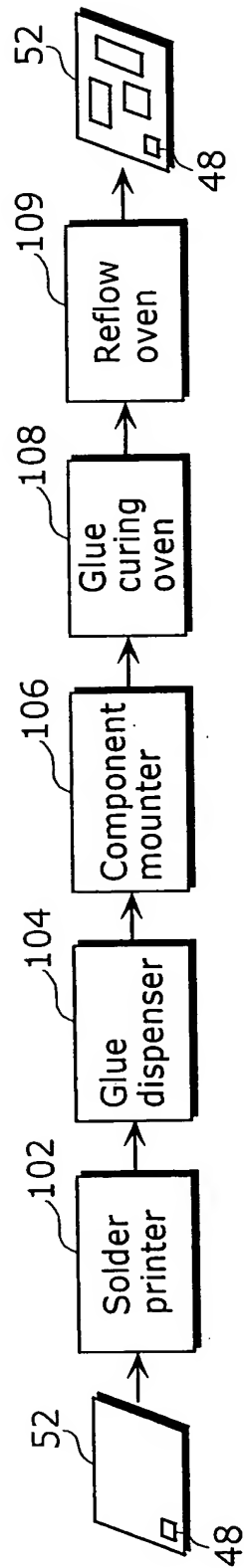


FIG. 6

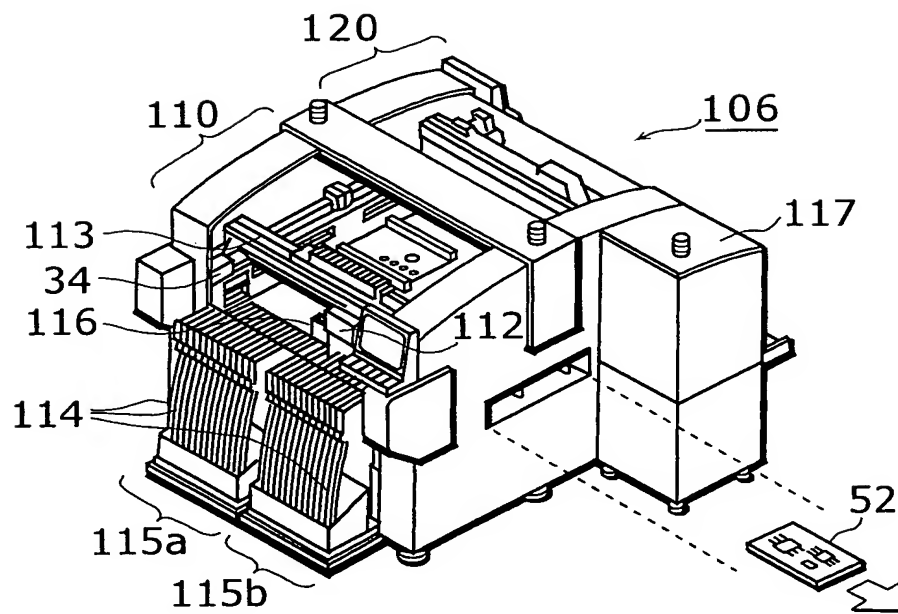
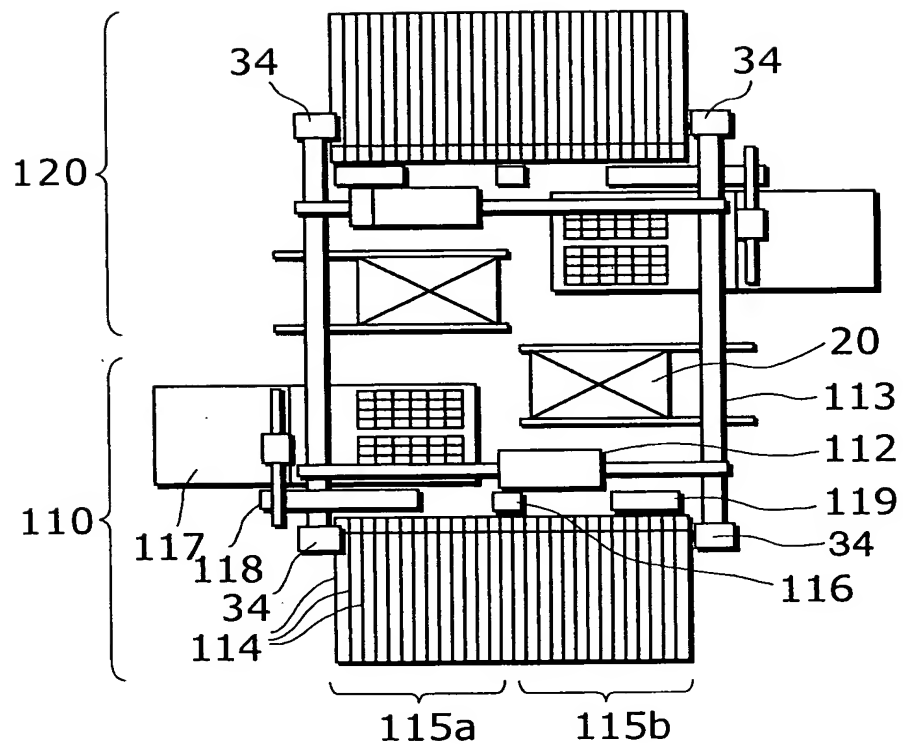


FIG. 7



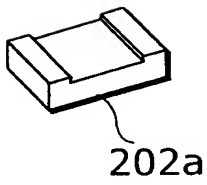


FIG. 8A

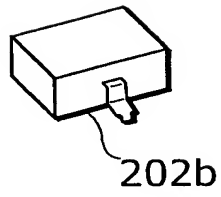


FIG. 8B

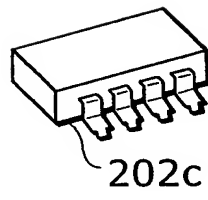


FIG. 8C

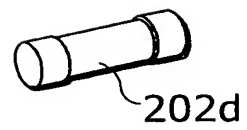


FIG. 8D

FIG. 9

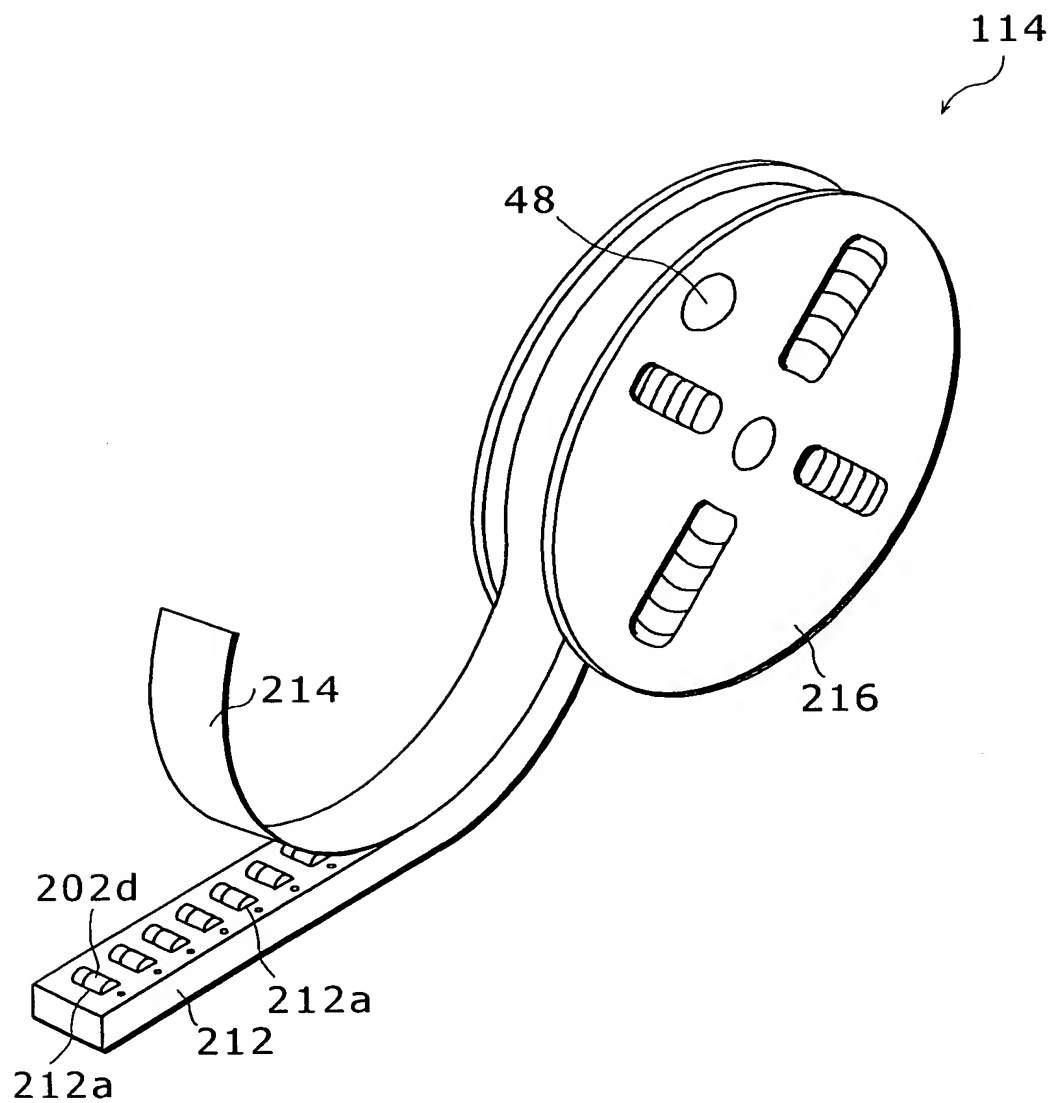


FIG. 10

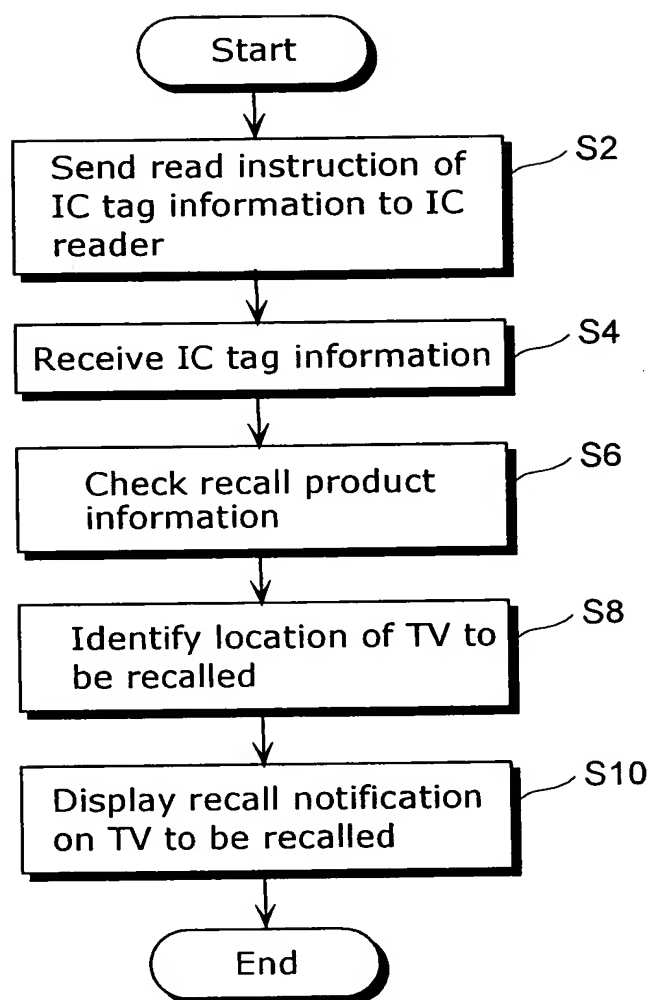


FIG. 11

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Name of manufacturing plant		Nara plant
Date of manufacturing		2000.1.1~2000.12.31
Component information	Name of component manufacturer	A
	Component product number	123
	Period of component manufacturing	1999.2.3~1999.10.1

FIG. 12

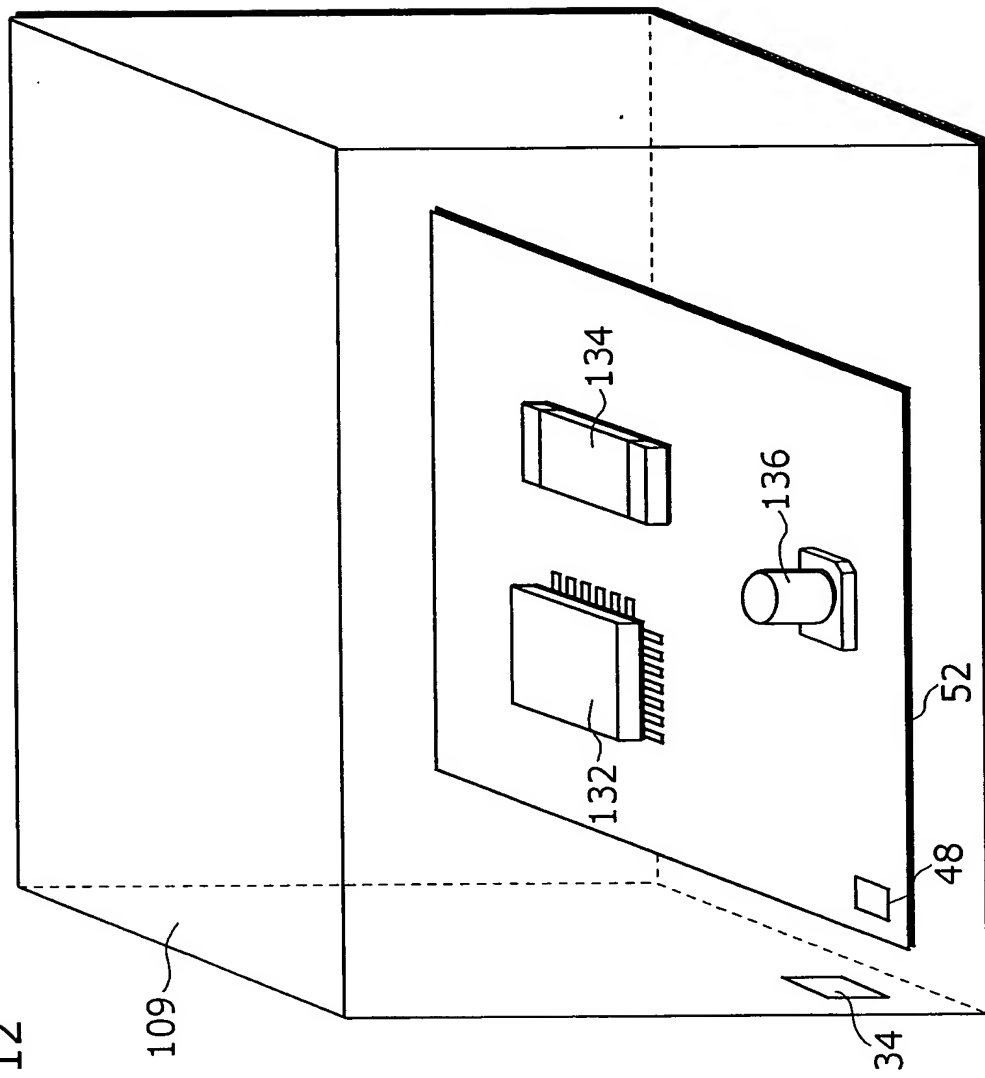


FIG. 13

Name of component	Heat resistant temperature	Temperature acceleration	Mounting location		
			x	y	θ
0603CR	200°C	1.5°C/ s ²	10	10	20
1005CR	150°C	3°C/ s ²	18	25	0
0112QP	300°C	5°C/ s ²	19	40	5

FIG. 14

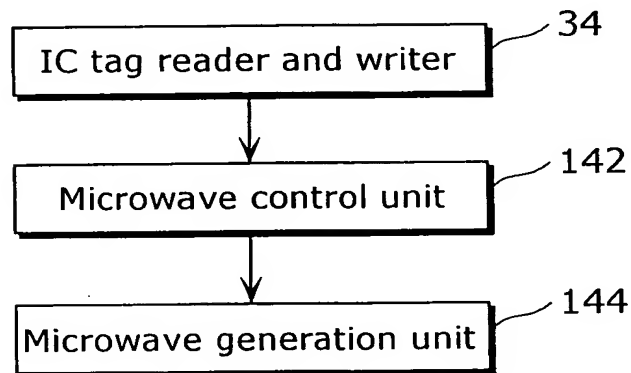
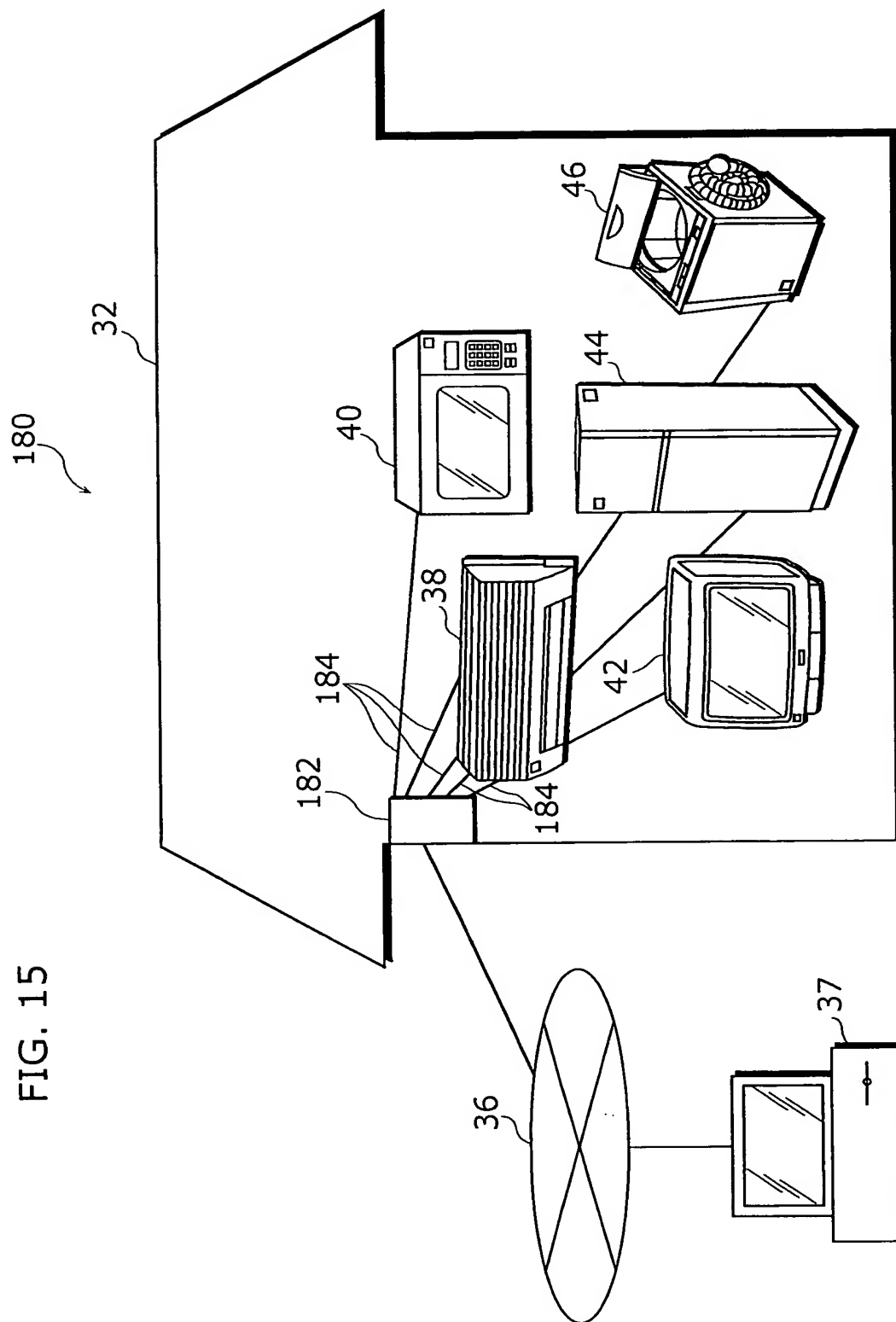


FIG. 15



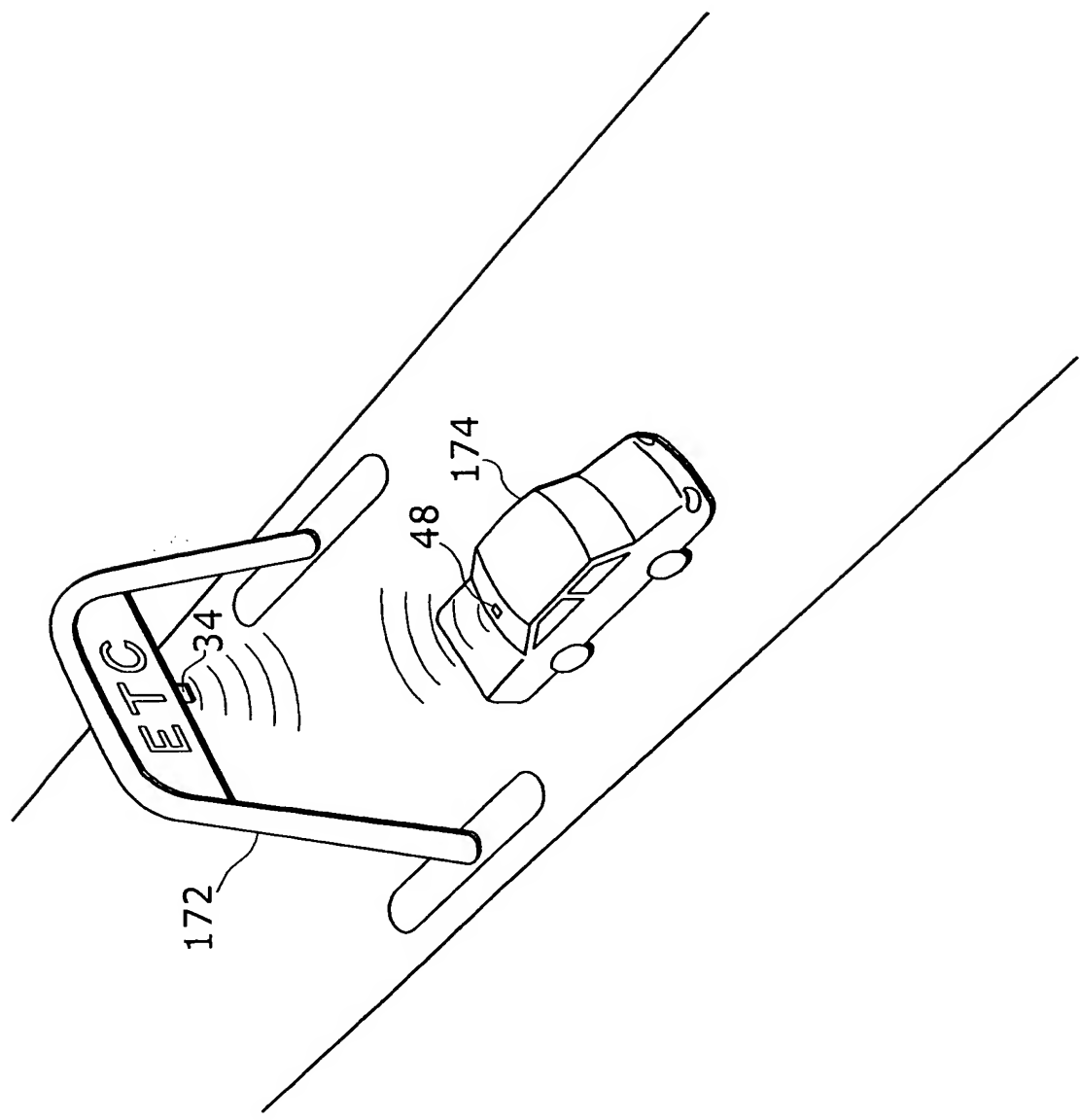


FIG. 16

FIG. 17

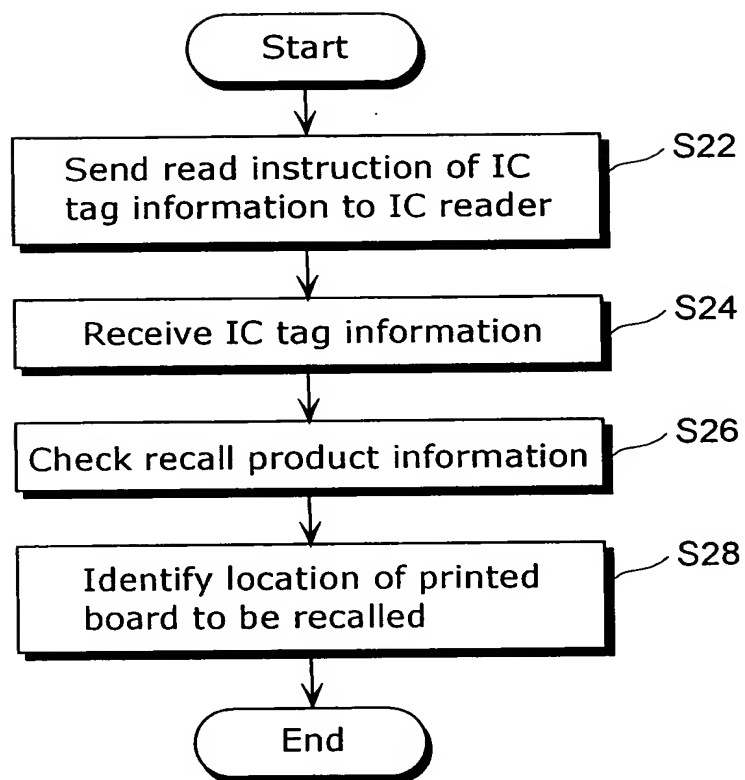


FIG. 18

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Printed board information	Product number	532C
	Lot number	1618

FIG. 19

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Component information	Product number	125A
	Lot number	38278

FIG. 20

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Component product number		241B
Mounting condition	Head in use	H204
	Pick-up nozzle in use	N335
	Tact time	Not more than 0.01sec
	Cassette in use	C384
	Camera in use	CMR849

FIG. 21

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Solder information	Product number	HA387
	Lot number	692AB
	Processing time	Not less than 30 minutes
Glue information	Product number	V187
	Lot number	3547B
	Processing time	Not less than 25 minutes

FIG. 22

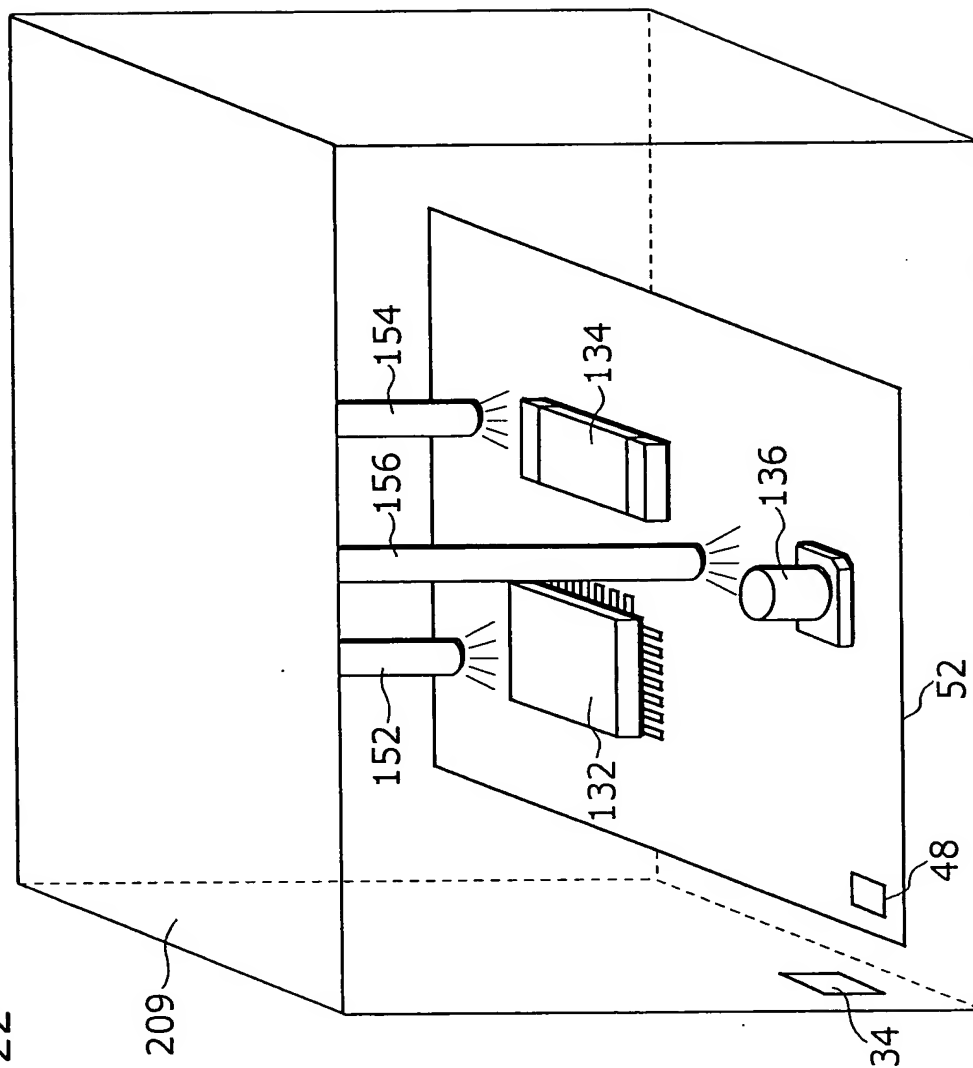


FIG. 23

